

## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>R</sub> WM V <sub>R</sub>	40	<b>V</b>
Average Rectified Output Current (Note 5) T <sub>T</sub> = +90°C	lo	3.0	Α
Non-Repetitive Peak Forward Surge Current, Single Sine-Wave Superimposed on Rated Load, 60Hz	I <sub>FSM</sub>	70	А

## **Thermal Characteristics**

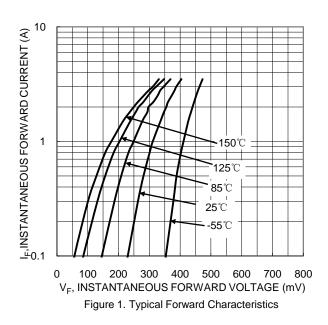
Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C

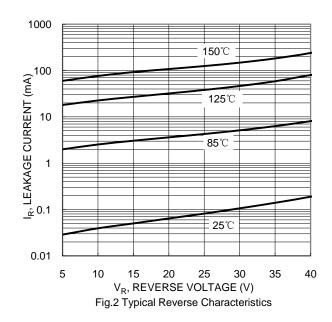
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	40			V	$I_R = 2.0 \text{mA}$
Forward Voltage Drop		_	0.310	0.350	V	I <sub>F</sub> = 1.0A
	VF	_	_	0.450		$I_F = 3.0A$
Leakage Current (Note 6)				150	μΑ	V <sub>R</sub> = 15V
	$I_R$	_	_	1.0	mA	$V_R = 20V$
			—	2.0	ША	$V_R = 40V$
Total Capacitance	Ст	_	180	_	pF	$f = 1MHz, V_R = 4.0VDC$
Thermal Resistance, Junction to Terminal	$R_{\theta JT}$	_	35	_	°C/W	_

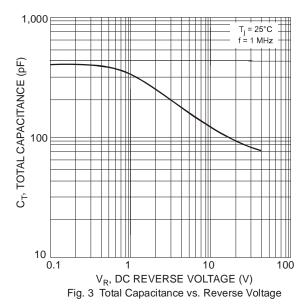
Notes:

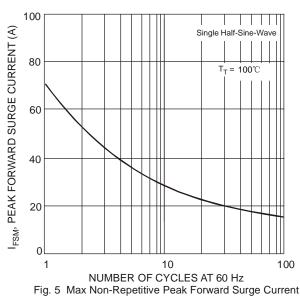
- $5.\ Device\ mounted\ on\ FR-4\ substrate,\ 0.4"*0.5",\ 2oz,\ single-sided,\ PC\ boards\ with\ 0.2"*0.25"\ copper\ pad.$
- 6. Short duration pulse test used to minimize self-heating effect.

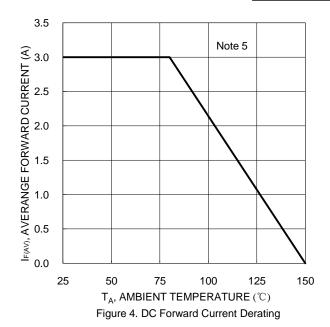










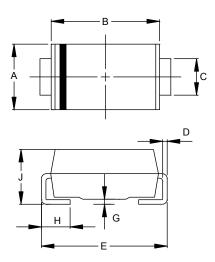




## **Package Outline Dimensions**

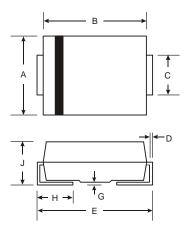
Please see http://www.diodes.com/package-outlines.html for the latest version.

### 1) Package Type:SMA



SMA		
Dim	Min	Max
Α	2.29	2.92
В	4.00	4.60
С	1.27	1.63
D	0.15	0.31
Е	4.80	5.59
G	0.05	0.20
H	0.76	1.52
7	1.96	2.40
All Dimensions in mm		

### 2) Package Type:SMB



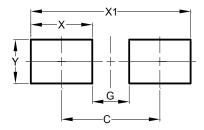
SMB		
Dim	Min	Max
Α	3.30	3.94
В	4.06	4.57
С	1.96	2.21
D	0.15	0.31
Е	5.00	5.59
G	0.05	0.20
Н	0.76	1.52
J	2.00	2.50
All Dimensions in mm		



## **Suggested Pad Layout**

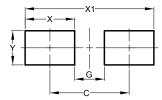
Please see http://www.diodes.com/package-outlines.html for the latest version.

### 1) Package Type:SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
Х	2.50
X1	6.50
Υ	1.70

## 2) Package Type:SMB



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Y	2.30



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